

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT6883858

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
STEFFEN ZIESCHE	06/02/2021
CHRISTIAN LENZ	07/05/2021
UWE WALTRICH	07/09/2021
CHRISTOPH BAYER	06/10/2021
HOANG LINH BACH	06/08/2021
ANDREAS SCHLETZ	06/10/2021
RECEIVING PARTY DATA	
Name:	FRAUNHOFER-GESELLSCHAFT ZUR FÖRDERUNG DER ANGEWANDTEN FORSCHUNG E.V.
Street Address:	HANSASTRASSE 27C
City:	MÜNCHEN
State/Country:	GERMANY
Postal Code:	80686
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17233867
CORRESPONDENCE DATA	
Fax Number:	(312)616-5700
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	312-616-5600
Email:	assignments@leydig.com
Correspondent Name:	LEYDIG, VOIT & MAYER, LTD.
Address Line 1:	TWO PRUDENTIAL PLAZA, STE. 4900
Address Line 2:	180 N. STETSON
Address Line 4:	CHICAGO, ILLINOIS 60601-6745
ATTORNEY DOCKET NUMBER:	753866
NAME OF SUBMITTER:	XAVIER PILLAI
SIGNATURE:	/Xavier Pillai/
DATE SIGNED:	08/25/2021

Total Attachments: 6

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ASSIGNMENT

WHEREAS, I/WE

(1) Steffen ZIESCHE, of c/o Fraunhofer Institut für Integrierte Systeme und Bauelementetechnologie, Schottkystraße 10, 91058 Erlangen, Germany,

(2) Christian LENZ, of c/o Fraunhofer Institut für Integrierte Systeme und Bauelementetechnologie, Schottkystraße 10, 91058 Erlangen, Germany,

(3) Uwe WALTRICH, of Nägelsbachstraße 58, 91052 Erlangen, Germany,

(4) Christoph BAYER, of c/o Fraunhofer Institut für Integrierte Systeme und Bauelementetechnologie, Schottkystraße 10, 91058 Erlangen, Germany,

(5) Hoang Linh BACH, of c/o Fraunhofer Institut für Integrierte Systeme und Bauelementetechnologie, Schottkystraße 10, 91058 Erlangen, Germany, and

(6) Andreas SCHLETZ, of c/o Fraunhofer Institut für Integrierte Systeme und Bauelementetechnologie, Schottkystraße 10, 91058 Erlangen, Germany,

hereinafter referred to as Assignor, have invented a certain invention entitled:

METHOD OF MANUFACTURING A POWER SEMICONDUCTOR COMPONENT
ARRANGEMENT OR A POWER SEMICONDUCTOR COMPONENT HOUSING

for which invention an application (provisional or non-provisional) for a U.S. patent was filed on April 19, 2021, under U.S. Application No. 17/233,867, and

WHEREAS, FRAUNHOFER-GESELLSCHAFT ZUR FÖRDERUNG DER ANGEWANDTEN FORSCHUNG E.V., of Hansastraße 27 c, 80686 München, Germany, hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in, to, and under the invention described in the patent application, including the entire priority right derived from the application,

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged,

Assignor assigns and transfers to Assignee and Assignee's legal representatives, successors, and assigns the entire right, title, and interest in, to, and under the invention, the referenced patent application, other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, national and regional phase applications, petty patent applications, and utility model applications) that may be filed in the U.S. and/or any country foreign to the U.S. on the invention, the patents that may issue thereon, and the patents as may be modified as the result of applicable procedures (e.g., supplemental examinations, ex parte reexaminations, inter partes reexaminations, inter partes reviews, post-grant reviews, and oppositions),

Assignor conveys to the Assignee the right to make applications in Assignee's own behalf for protection of the invention in the U.S. and countries foreign to the U.S. and to claim priority to the referenced patent application and other such applications that may be filed in the U.S. or any country foreign to the U.S. on the invention under the Patent Cooperation Treaty, the Paris Convention, and any other international arrangements,

Assignor will not execute any writing or do any act conflicting with the terms of this assignment,

Assignor will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to pursue the patent applications identified herein, including, but not limited to, rendering all necessary assistance in making applications for and obtaining patents that may issue thereon in the U.S. and any countries foreign to the U.S. on the invention, and in enforcing any rights accruing as a result of such applications or patents, by, for example, executing statements and other affidavits,

Assignor and Assignee agree the terms of this assignment shall bind, and inure to the benefit of, the legal representatives, successors, and assigns of all parties hereto,

Assignor authorizes Assignee to insert in this assignment the number and filing date of the application if the number and filing date of the application are not recited herein at the time of execution of this assignment by any or all of the parties hereto,

Assignor and Assignee agree that U.S. law governs this assignment, and

Assignee acknowledges and accepts this assignment.

IN WITNESS WHEREOF, Assignor has hereunder set his/her hand on the date shown below.

Date 02.06. 2007

Steffen Ziesche
Assignor: Steffen ZIESCHE

Date _____

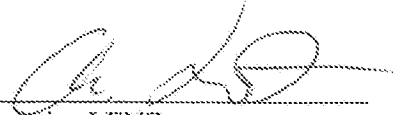
Witness: _____

Date _____

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Date 05.07.2021



Assignor: Christian LENZ

Date _____

Witness: _____

Date _____

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Date _____

Assignor: Uwe WALTRICH

Date _____

Witness: _____

Date _____

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Date _____

Assignor: Christoph BAYER

Date _____

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Date _____
Assignor: Christian LENZ

Date _____
Witness: _____

Date _____
Witness: _____

Date 09.07.2021 _____
Assignor: Uwe WALTRICH

Date 9.07.21 _____
Witness: Uwe Waltrich

Date 13.7.21 _____
Witness: Uwe Waltrich

Date _____
Assignor: Christoph BAYER

Date _____
Witness: _____

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Assignor: Christian LENZ

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Date _____
Assignor: Uwe WALTRICH

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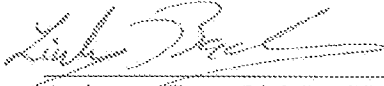
Date 10th June 2004 _____
Assignor: Christoph BAYER

Date _____
Witness: _____

Date _____
Witness: _____

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Date 08.06.2021


Assignor: Hoang Linh BACH

Date _____

Witness: _____

Date _____

Witness: _____

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Date 10.06.21


Assignor: Andreas SCHLETZ

Date _____

Witness: _____

Date _____

Witness: _____

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